

C1206C681KBGACTU

Aliases (C1206C681KBGAC7800) SMD Comm COG HV, Ceramic, 680 pF, 10%, 630 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 1206, 1.5 mm



General Information			
Series	SMD Comm COG HV		
Style	SMD Chip		
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I		
Features	Ultra-Stable, Low Loss, Class I		
RoHS	Yes		
Termination	Tin		
Marking	No		
AEC-Q200	No		
Typical Component Weight	25 mg		
Shelf Life	78 Weeks		
MSL	1		

Dimensions		
Chip Size	1206	
L	3.2mm +/-0.2mm	
W	1.6mm +/-0.2mm	
Т	1mm +/-0.10mm	
S	1.5mm MIN	
В	0.5mm +/-0.25mm	

Т	1mm +/-0.10mm		
S	1.5mm MIN		
В	0.5mm +/-0.25mm		
Packaging Specifications			

2500

Packaging

Packaging Quantity

T&R, 180mm, Plastic Tape

Specifications		
Capacitance	680 pF	
Measurement Condition	1 MHz 1.0Vrms	
Tolerance	10%	
Voltage DC	630 VDC	
Dielectric Withstanding Voltage	945 VDC	
Temperature Range	-55/+125°C	
Temp. Coefficient	COG	
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms	
Dissipation Factor	0.1% 1 MHz 1.0Vrms	
Aging Rate	0% Loss/Decade Hour	
Insulation Resistance	100 GOhms	

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

Generated 05/05/2025 © 2006 - 2025 YAGEO